PMP7967 REVA

Designator	Description	Manufacturer	PartNumber	Quantity
	Printed Circuit Board	Any	PRJ_Number	1
	CAP, AL, 330uF, 160V, +/-20%, TH	Nichicon	UCY2C331MHD	4
C33, C50	- , ,,,			
	CAP, CERM, 4.7uF, 50V, +/-10%, X7R, 1206	MuRata	GRM31CR71H475KA12L	16
C6, C21,				
C22, C23,				
C24, C35,				
C36, C37,				
C38, C52,				
C53, C54,				
C55				
	CAP, CERM, 1uF, 200V, +/-10%, X7R, 1825	Kemet	C1825X105K2RACTU	4
C39, C56				
	CAP, CERM, 100pF, 50V, +/-5%, C0G/NP0, 0603	MuRata	GRM1885C1H101JA01D	4
C41, C58				
	CAP, CERM, 0.47uF, 25V, +/-10%, X7R, 0603	MuRata	GRM188R71E474KA12D	4
C43, C59				
	CAP, CERM, 1uF, 25V, +/-10%, X7R, 0603	MuRata	GRM188R71E105KA12D	4
C44, C60				
C12, C30,	CAP, CERM, 470pF, 100V, +/-5%, C0G/NP0, 0805	MuRata	GRM2165C2A471JA01D	4
C45, C46				
C13	CAP, CERM, 1uF, 16V, +/-10%, X7R, 0603	MuRata	GRM188R71C105KA12D	1
	CAP, CERM, 0.047uF, 25V, +/-10%, X7R, 0603	MuRata	GRM188R71E473KA01D	1
C15, C17,	RES, 0 ohm, 5%, 0.125W, 0805	Vishay-Dale	CRCW08050000Z0EA	8
C48, C61,				
D1, D2, D3,				
D5				
C16, C42	CAP, CERM, 1000pF, 50V, +/-5%, C0G/NP0, 0603	TDK	C1608C0G1H102J	2
C18	CAP, CERM, 0.22uF, 16V, +/-10%, X7R, 0603	TDK	C1608X7R1C224K	1
C31, C47,	CAP, CERM, 0.1uF, 25V, +/-10%, X7R, 0603	MuRata	GRM188R71E104KA01D	3
C49				
C32	CAP, CERM, 2.2uF, 16V, +/-10%, X5R, 0603	MuRata	GRM188R61C225KE15D	1
C62	CAP, AL, 100uF, 63V, +/-20%, 0.35 ohm, SMD	Panasonic	EEE-FK1J101P	1
FID1, FID2,	Fiducial mark. There is nothing to buy or mount.	N/A	N/A	6
FID3, FID4,				
FID5, FID6				
H1, H2, H3,	Machine Screw, Round, #4-40 x 1/4, Nylon, Philips	B&F Fastener Supply	NY PMS 440 0025 PH	4
H4	panhead			
IN1, OUT1,	Test Point, TH, Compact, White	Keystone	5007	6
Sync In 1,				
Sync In 2,				
Sync In 3,				
Sync In 4				
J1, J2	Terminal 50A Lug	Panduit	CB35-36-CY	2
J3, J4, J5,	Standard Banana Jack, Uninsulated, 8.9mm	Keystone	575-8	4
J6				
L1, L2, L3,	Inductor, Shielded Drum Core, WE-HCI 82uH, 7A,	Wurth Elektronik eiSos	7443551130	4
	0.0304 ohm, SMD			
Q1, Q3, Q5,	Diode, Ultrafast, 200V, 3A, SMC	Diodes, Inc.	MURS320-13-F	4
Q7				
Q2, Q4, Q6,	MOSFET, N-CH, 150V, 50A, PG-TDSON-8	Infineon Technologies	BSC190N15NS3 G	4
Q8				
R1, R20,	RES, 0.01 ohm, 1%, 1W, 2512	Vishay-Dale	WSL2512R0100FEA	4
R31, R44			1	

Designator	Description	Manufacturer	PartNumber	Quantity
R2, R4,	RES, 221 ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW0603221RFKEA	8
R21, R22,				
R32, R33,				
R45, R46				
R6	RES, 10.7k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW060310K7FKEA	1
R7, R25,	RES, 3.3 ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW06033R30JNEA	4
R36, R49				
R8	RES, 2.67k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW06032K67FKEA	1
R9, R10,	RES, 0 ohm, 5%, 0.1W, 0603	Panasonic	ERJ-3GEY0R00V	8
R27, R28,				
R39, R41,				
R51, R52				
R12, R30,	RES, 60.4k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW060360K4FKEA	4
R43, R54				
R15	RES, 51k ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW060351K0JNEA	1
R16	RES, 1.21k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW06031K21FKEA	1
R17	RES, 88.7k ohm, 1%, 0.125W, 0805	Vishay-Dale	CRCW080588K7FKEA	1
R18	RES, 20 ohm, 5%, 0.125W, 0805	Vishay-Dale	CRCW080520R0JNEA	1
R24, R38	RES, 10.0k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW060310K0FKEA	2
R26	RES, 0 ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW06030000Z0EA	1
R35	RES, 18.0k ohm, 0.1%, 0.1W, 0603	Yageo America	RT0603BRD0718KL	1
R37	RES, 499 ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW0603499RFKEA	1
R40	RES, 1.50k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW06031K50FKEA	1
R48, R50,	RESISTOR 7.5 OHM 3/4W 5% 2010	Panasonic	ERJ-12ZYJ7R5U	4
R55, R56				
R57	RES, 100k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW0603100KFKEA	1
R58	RES, 158k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW0603158KFKEA	1
SW1, SW2,	Test Point, TH, Miniature, White	Keystone	5002	4
SW3, SW4				
U1, U3, U4,		ТІ	LM5122MH	4
U7				
U5	IC OSC MONO TIMING 3MHZ 8-SOIC	National Semiconductor	LMC555CMX	1
U6	IC 10-OUT DECADE COUNTER 16-SOIC		CD4017BM96	1
U8	Series of Adjustable Micropower Voltage Regulators, 8-	National Semiconductor	LP2951CSD	1
	pin LLP			
Vin Gnd,	Test Point, TH, Miniature, Black	Keystone	5001	2
Vout Gnd				
Vin, Vout	Test Point, TH, Miniature, Red	Keystone	5000	2

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